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The 2023 IEEE Microwave and Wireless Components Letter Tatsuo Itoh Prize is awarded to F. Thome and A. Leuther for their paper entitled "A 75–305-GHz Power Amplifier MMIC With 10–14.9-dBm Pout in a 35-nm InGaAs mHEMT Technology," IEEE Microwave and Wireless Components Letters, Vol. 31, Issue: 6, pp. 741-743, June 2021

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